IGBT - Inverter Welding

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for welding applications. Incorporated into the device is a soft and fast co–packaged free wheeling diode with a low forward voltage.

Features

- Low Switching Loss Reduces System Power Dissipation
- $T_{Jmax} = 175^{\circ}C$
- Soft, Fast Free Wheeling Diode
- This is a Pb–Free Device

Typical Applications

• Welding

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	600	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ι _C	90 45	A
Pulsed collector current, T_{pulse} limited by T_{Jmax}	I _{CM}	180	A
Diode forward current @ Tc = 25°C @ Tc = 100°C	l _F	90 45	A
Diode pulsed current, T_{pulse} limited by T_{Jmax}	I _{FM}	180	A
Gate-emitter voltage Transient Gate Emitter Voltage ($t_p = 5 \ \mu s, D < 0.010$)	V _{GE}	±20 ±30	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	300 150	W
Operating junction temperature range	TJ	-55 to +175	°C
Storage temperature range	T _{stg}	-55 to +175	°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C

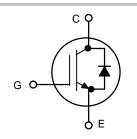
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

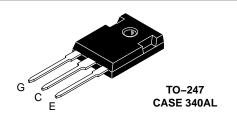


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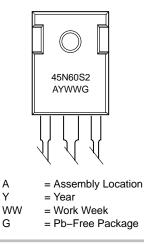
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45 A, 600 V V_{CEsat} = 2.0 V E_{off} = 0.36 mJ





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTB45N60S2WG	TO–247 (Pb–Free)	30 Units / Rail

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.50	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ ext{ heta}JC}$	1.46	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

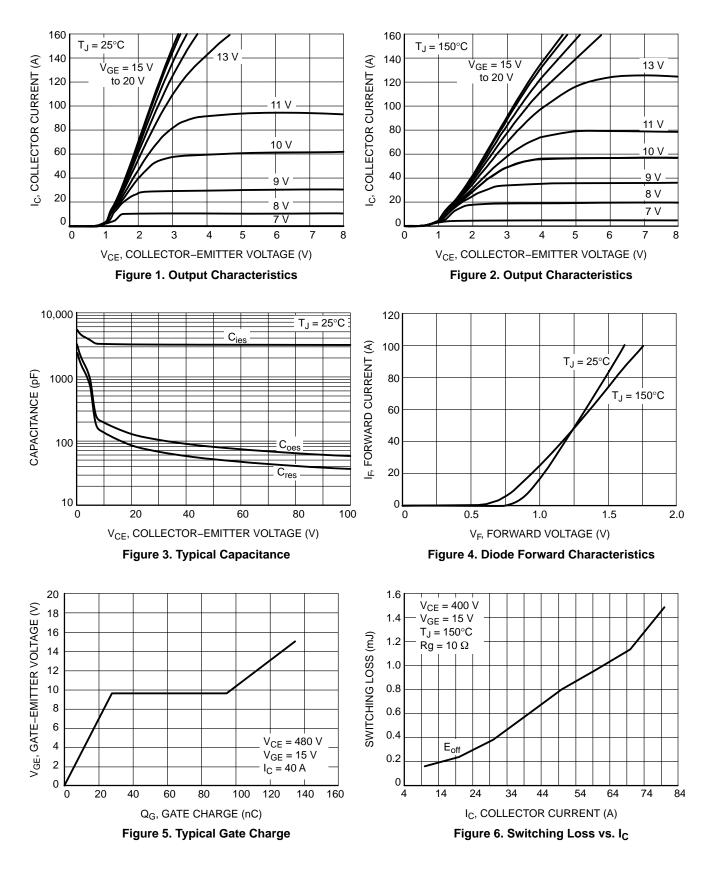
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	•					
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 µA	V _{(BR)CES}	600	-	_	V
Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 45 A V _{GE} = 15 V, I _C = 45 A, T _J = 175°C	V _{CEsat}	-	2.0 2.5	2.3 -	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$, $I_C = 150 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 \text{ V}, V_{CE} = 600 \text{ V}$ $V_{GE} = 0 \text{ V}, V_{CE} = 600 \text{ V}, T_{J} = 175^{\circ}\text{C}$	I _{CES}		_ _	0.2 2	mA
Gate leakage current, collector-emitter short-circuited	V_{GE} = 20 V , V_{CE} = 0 V	I _{GES}	_	-	100	nA
DYNAMIC CHARACTERISTIC						
Input capacitance		C _{ies}	_	3200	_	pF
Output capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz	C _{oes}	-	130	-	-
Reverse transfer capacitance		C _{res}	-	85	_	
Gate charge total	V _{CE} = 480 V, I _C = 45 A, V _{GE} = 15 V	Qg	-	135	_	nC
Gate to emitter charge		Q _{ge}	-	27	-	-
Gate to collector charge		Q _{gc}	-	67	-	
SWITCHING CHARACTERISTIC, INDUCT	TIVE LOAD					
Turn-off delay time	$\begin{array}{c} {{\rm T_{J}}} = 25^{\circ}{\rm C} \\ {{\rm V_{CC}}} = 400 \; {\rm V, I_{C}} = 45 \; {\rm A} \\ {{\rm R_{g}}} = 10 \; \Omega \\ {{\rm V_{GE}}} = 0 \; {\rm V/} \; 15 \; {\rm V} \end{array}$	t _{d(off)}	-	151	-	ns
Fall time		t _f	-	55	-	
Turn-off switching loss		E _{off}	-	0.36	-	mJ
Turn-off delay time	$T_{J} = 150^{\circ}C$ V _{CC} = 400 V, I _C = 45 A R _g = 10 Ω V _{GE} = 0 V/ 15 V	t _{d(off)}	-	154	-	ns
Fall time		t _f	-	78	-	
Turn-off switching loss		E _{off}	-	0.69	-	mJ
DIODE CHARACTERISTIC						
Forward voltage	$V_{GE} = 0 V$, $I_F = 45 A$ $V_{GE} = 0 V$, $I_F = 45 A$, $T_J = 175^{\circ}C$	V _F	-	1.2 1.2	1.4 -	V
Reverse recovery time	$T_J = 25^{\circ}C$ $I_F = 45 A, V_R = 200 V$ $di_F/dt = 200 A/\mu s$	t _{rr}	_	498	-	ns
Reverse recovery charge		Q _{rr}	_	9400	-	nc
Reverse recovery current		Irrm	_	36	_	Α

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

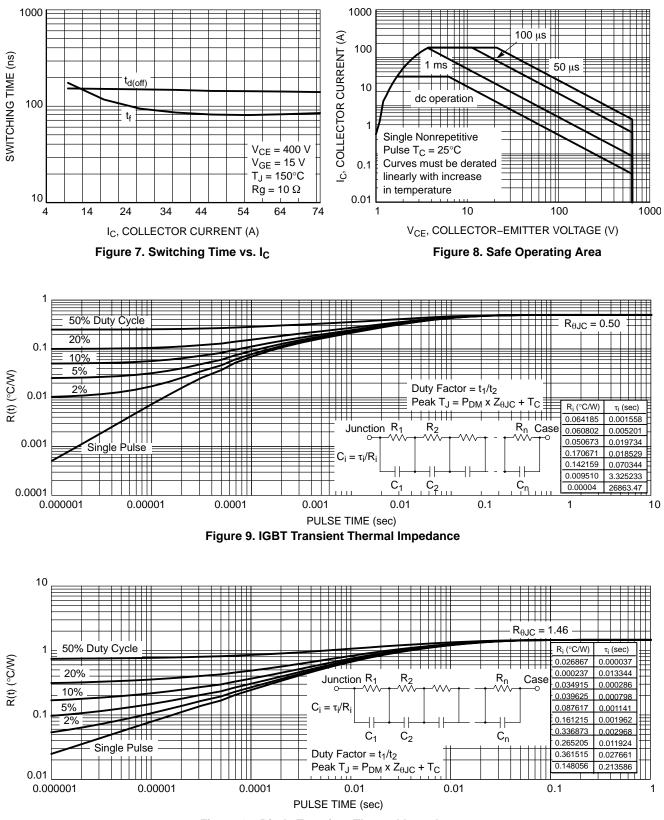
Irrm

Reverse recovery current

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

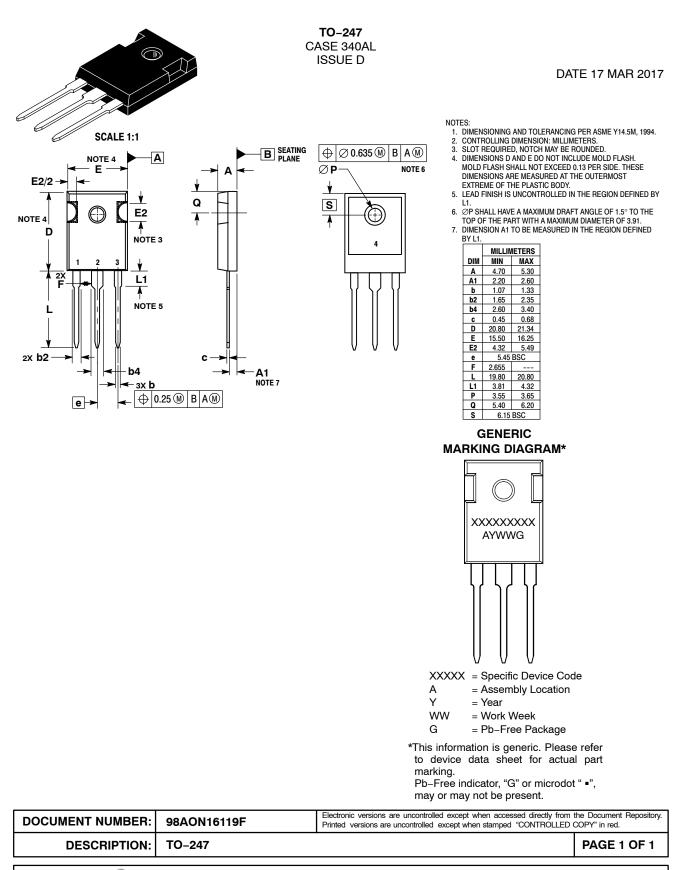




MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS





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